

# ES2AF THRU ES2JF

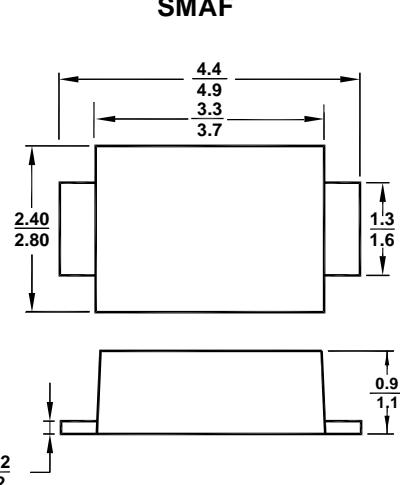
**Glass Passivated Super Fast Rectifier**  
**Reverse Voltage - 50 to 600 V**  
**Forward Current - 2 A**

## Features

- Glass Passivated Chip Junction
- For surface mounted applications
- Low profile package
- Superfast reverse recovery time

## Mechanical Data

- **Case:** SMAF
- **Terminals:** Solder plated, solderable per MIL-STD-750, Method 2026



All Dimensions in mm

## Absolute Maximum Ratings and Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	Symbols	ES2AF	ES2BF	ES2CF	ES2DF	ES2EF	ES2GF	ES2JF	Units
Marking	ES2A	ES2B	ES2C	ES2D	ES2E	ES2G	ES2J	-	
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	50	100	150	200	300	400	600	V
Maximum RMS Voltage	V <sub>RMS</sub>	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current at T <sub>L</sub> =100°C	I <sub>F(AV)</sub>							2	A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>							50	A
Maximum Forward Voltage at 2 A	V <sub>F</sub>				1		1.25	1.7	V
Maximum Reverse Current at Rated DC Blocking Voltage	I <sub>R</sub> T <sub>a</sub> = 25°C T <sub>a</sub> = 125°C				5		100		µA
Typical Junction Capacitance at V <sub>R</sub> = 4 V, f = 1 MHZ	C <sub>j</sub>				60				pF
Maximum Reverse Recovery Time at I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> = 0.25 A	t <sub>rr</sub>				35				ns
Typical Thermal Resistance	R <sub>θJA</sub>				75				°C/W
Operating Junction and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>				- 55 to + 150				°C



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